AN6360, AN6360S

VTR Color ACC Circuits

Outline

The AN6360 and the AN6360S are integrated circuits designed for VTR color ACC and constitute a color processing circuit by combining with the AN6361N, the AN6362 or the AN6362S.

Features

· The funcions consist of :

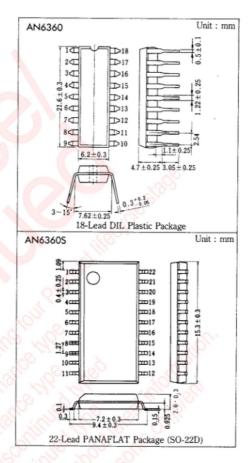
ACC circuit

Balanced modulator

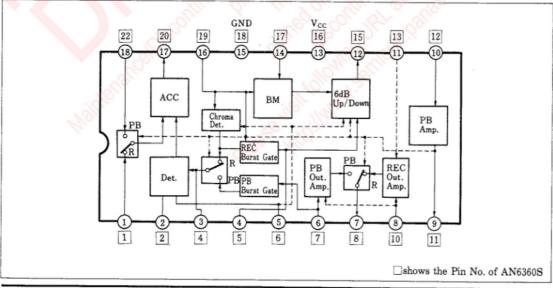
Burst 6 dB up/down circuit

Play back amplifier

Supply voltage either 9V or 12V



Block Diagram



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Pin No. of AN6360S

Pin No.	in No. Pin Name		Pin Name		
1 (1)	ACC Rec. Input	0.40	P.B. Amp. Output		
2 (2)	Burst Detect	9 (11)	R/P.B. Select		
3 (4)	Burst Output	10 (12)	P.B. Amp. Input		
4 (5)	Burst Gate Pulse Input	11 (13)	Rec. Current Select		
5 (6)	Chroma Select Burst	12 (15)	B.M. Output		
	6 dB up/down Select	13 (16)	V _{cc}		
6 (7)	Output Amp.	14 (17)	Carrier Input		
	P.B. Chroma Input	15 (18)	GND		
7 (8)	Chroma Output	16 (19)	Signal Input		
8 (10)	Output Amp. Rec. Chroma	17 (20)	ACC Output		
	Input C/B/B/W Select	18 (22)	ACC P.B. Input		

In case of AN6460S, Pin No.3, 9, 4, 2 are NC

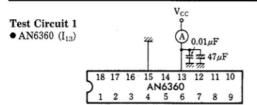
■ Absolute Maximum Ratings (Ta=25°C)

Item Supply voltage		Symbol	Rating	Unit V	
		Vcc	14.4		
Power dissipation	AN6360	,	550	mW	
$(Ta = 70^{\circ}C)$	AN6360S	P_{D}	270*		
Operating ambient temperature		T_{copr}	-20~+70	°C	
Storage temperature	AN6360	d.	-40~+150	eC.	
Storage temperatur	AN6360S	stg	-40~+125	°C	

* Indicates a package capability.

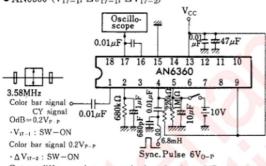
■ Electrical Characteristics (V_{cc}=12V, Ta=25℃±2℃)

ltem	Symbol	Test Circuit	Condition	min.	typ.	max.	Unit	
Circuit current	AN6360 AN6360S	I ₁₃ I ₁₆	1	100 101 CA	20		40	mA
Pec. AGC output AN6360 amplitude(Burst AGC) AN6360S		V ₁₇₋₁ V ₂₀₋₁	2	v ₁ Chroma, 0.2V _{P-P}	0.3	1000	0.65	V _{P-P}
Rec. AGC control AN6360 sensitivity (Burst AGC) AN63605		∆v ₁₇₋₁ △v ₂₀₋₁	2	+6dB~-15dB	131.	100	3.5	dB
Rec. AGC control AN6360 sensitivity (Chroma AGC) AN6360S		ΔV_{17-2} ΔV_{20-2}	2	CY Signal	2	205	5	dB
Rec./PB cross talk AN6360 AN63605		CT ₁₇ CT ₂₀	3	υ ₁ =3.58MHz, 0.1V _{P-P}	0,0	000	-40	dB
Rec. burst gate gain AN6360 AN6360S		G _{V16-3} G _{V19-4}	4	v ₁₆ Chroma Signal, 0.4V _{P-P}	12.9		16.1	dB
PB burst gate gain AN6360 AN6360S		G _{V6-3} G _{V7-4}	4	υ ₆ Chroma Signal, 0.2V _{P-P}	18.4		21.6	dB
B.M. output amplitude	AN6360S	υ ₀₁₂ υ ₀₁₅	5	11011 011	1		1.5	V_{P-P}
B.M. carrier leak AN6360 AN6360S		CL ₁₂ CL ₁₅	5	× 10, 11;			-40	dB
Burst emphasis amount		G _(EmpH)	5	:Sr M	5		7	dB
Burst de-emphasis amount		G _(1)-Emph)	5	2 1/4	-7		-5	dB
PB amp. gain AN6360 AN6360S		G _{V10-9} G _{V12-11}	6	v ₁₀ 0.2V _{P-P}	16		20	dB
Rec. output amp. gain(1) AN6360 AN6360S		G _{V8-1} G _{V10-1}	7	SP mode	12		15	dB
Rec. output amp. gain(2) AN6360 AN6360S		G _{V8-2} G _{V10-2}	7	LP mode	0.5		2.5	dB
PB output amp. gain AN6360 AN6360S		G _{V6-7} ·G _{V7-8}	7		7		10	dB
Monochrome/color cross AN6360 talk AN6360S		CT ₇	8				-40	dB
Rec./PB select sensitivity AN6360 AN6360S		S ₉ S ₁₁	3	P.B.→Rec.	9			V
Rec. output amp. LP/SP AN6360 select sensitivity AN6360S		S ₁₁ S ₁₃	7	SP→LP	9			V
Monochrome/color select AN6360 sensitivity AN6360S		S ₈ S ₁₀	8	Color→ monochrome			1.5	V



Test Circuit 2

AN6360 (V₁₇₋₁, △v₁₇₋₁, △V₁₇₋₂)

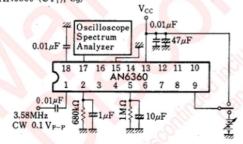


Output difference between color bar signals + 6dB and -15dB $\cdot \Delta V_{17-2}$: SW-OFF

Burst output difference between CY section 0.2 VP-P and 0, with CY signal 0.2 Vp. p

Test Circuit 3

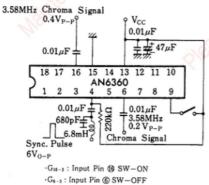
AN6360 (CT₁₇, S₉)

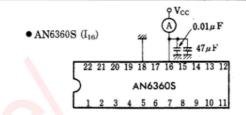


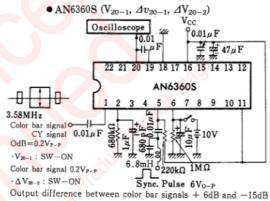
- CT17 : Pin @ output difference between Pin @ Vcc and Open
- So : Pin (9) voltage when Pin (7) output is normally made

Test Circuit 4

AN6360 (G_{V16-3}, G_{V6-3})

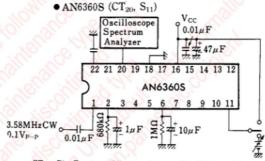




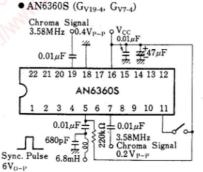


· A V20-2 : SW-OFF

Burst output difference between CY section 0.2 V_{P-P} and 0, with CY signal 0.2 Vp-



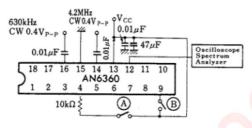
- CT20 : Pin @ output difference between Pin D Vcc and Open
- Sit : Pin 4D voltage when Pin @ output is normally made



·Gvis-4: Input Pin @ SW-ON ·Gvr-4: Input Pin ⑦ SW-OFF

Test Circuit 5

AN6360 (v_{O12}, CL₁₂, G_(Emph), G_(D-Emph))

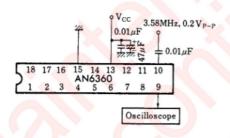


· V12, Lfc12 : SW-OFF

· G(Emph) : SWA ON/OFF difference with SWB-ON
· G(D-Emph) : SWA ON/OFF difference with
SWB-OFF

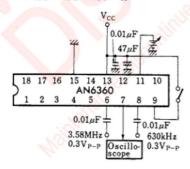
Test Circuit 6

AN6360 (G_{V10-9})



Test Circuit 7

• AN6360 (G_{V8-1}, G_{V8-2}, G_{V6-7}, S₁₁)



SW-ON, Pin@ OV, V1 @ f=630kHz, 0.3VP-P

· Gv8-2:

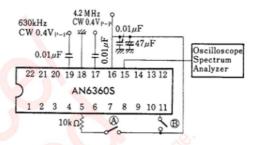
SW-ON, Pin@ Vcc, Vi & f=630kHz, 0.3Vp-p, Obtain at a ratio to Gs-1.

· Gv6-7:

SW-OFF, V_1 6 f=3.58MHz, $0.3V_{P-P}$

SW-ON, Vi (8) f=630kHz, 0.3V_{Pap}. Voltage when Pin ① output goes up by about 1.5 dB by increasing a Pin ① voltage from 0V.

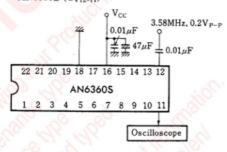
• AN6360S (v_{O15} , CL_{15} , $G_{(Emph)}$, $G_{(D-Emph)}$)



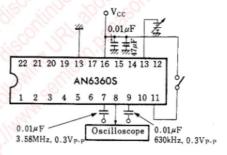
·V15, CL15 : SW-OFF

·G(Emph) : SWA ON/OFF difference with SWB-ON ·G(D-Emph) : SWA ON/OFF difference with

• AN6360S (G_{V12-11})



AN6360S (G_{V10-1}, G_{V10-2}, G_{V7-8}, S₁₃)



SW-ON, Pin@ 0V, V, @ f=630kHz, 0.3VP-P

·Gv10-2

SW-ON, Pin@ V_{cc} , V_{I} @ f = 630kHz, $0.3V_{P-P}$,

Obtain at a ratio to Gvie-1-

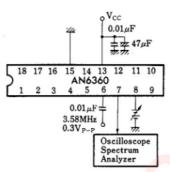
·G_{V7-8}: SW-OFF, $V_I \textcircled{?} f=3.58MHz$, $0.3V_{P-P}$

· S13

SW-ON, V_1 \oplus f = 630 kHz, $0.3 V_{P-P}$. Voltage when Pin 8 output goes up by about 1.5 dB by increasing a Pin @ voltage from 0V.

Test Circuit 8

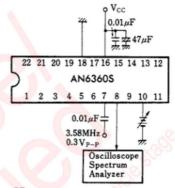
• AN6360 (CT₇, S₈)



·CTr: Pin ② output difference between Pin ⑧Open and 0V -Ss.

·S₈:
Pin ® voltage when Pin ⑦ output is normally made by increasing a Pin ® voltage from 0V.

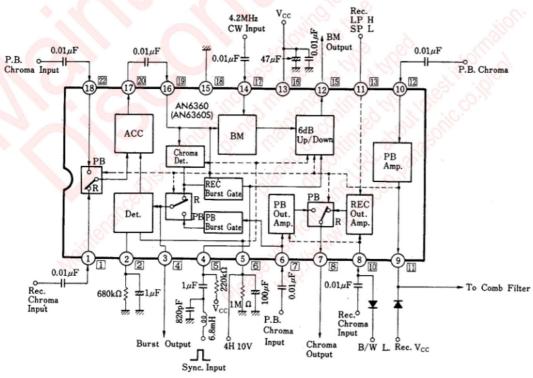
AN6360S (CT₈, S₁₀)



·CTa: Pin ® output difference between Pin @Open and 0V ·Sis:

Pin @ voltage when Pin ® output is normally made by increasing a Pin @ voltage from 0V.

Application Circuit



Precautions for Use

□shows the Pin No. of AN6360S

- 1. Set a Pin (5) H voltage (burst 6 dB up/down stop) within a range of 8V to 10V. (AN6360S: Pin (6))
- 2. Set the Pin 1 to Vcc or Open when a recording current is not switched. (AN6360S: Pin 3)

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